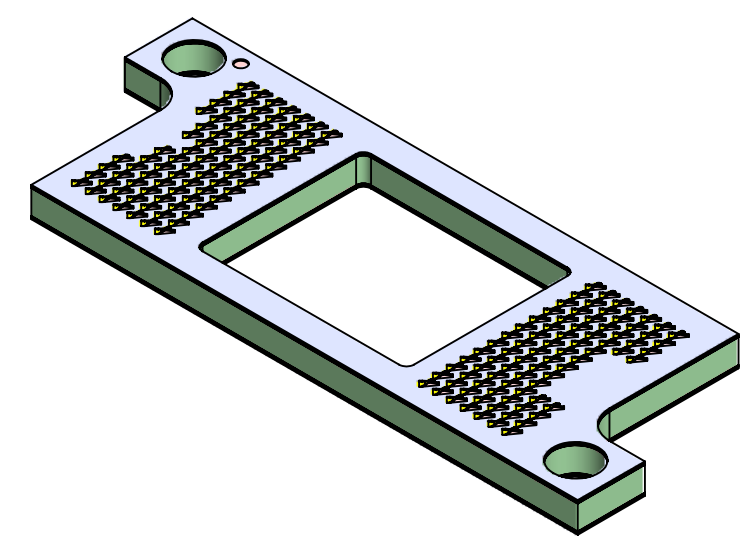
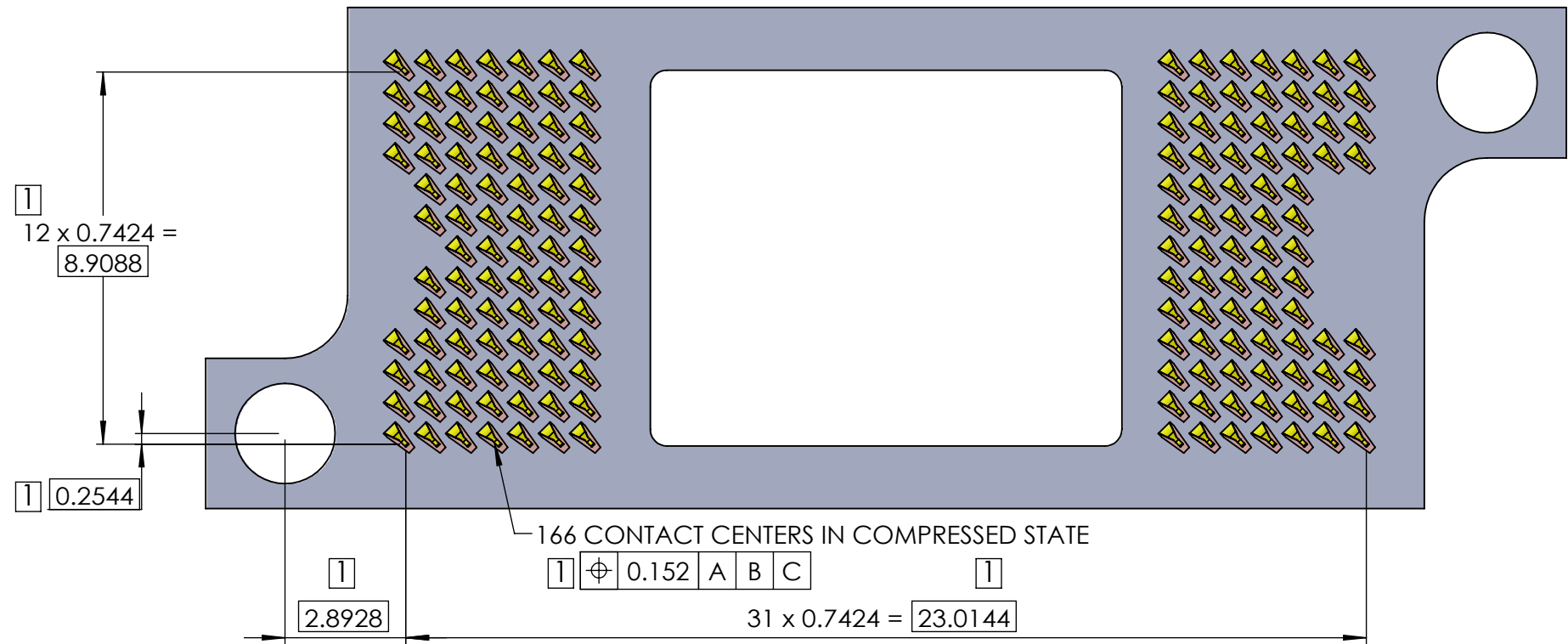
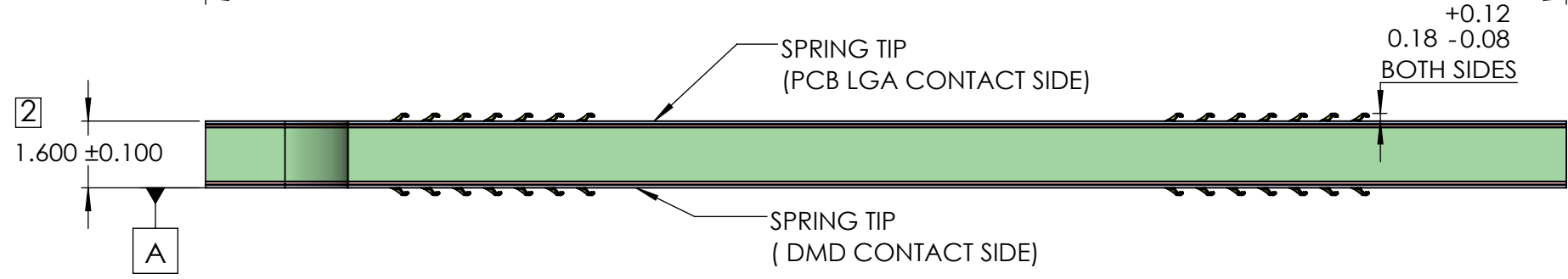
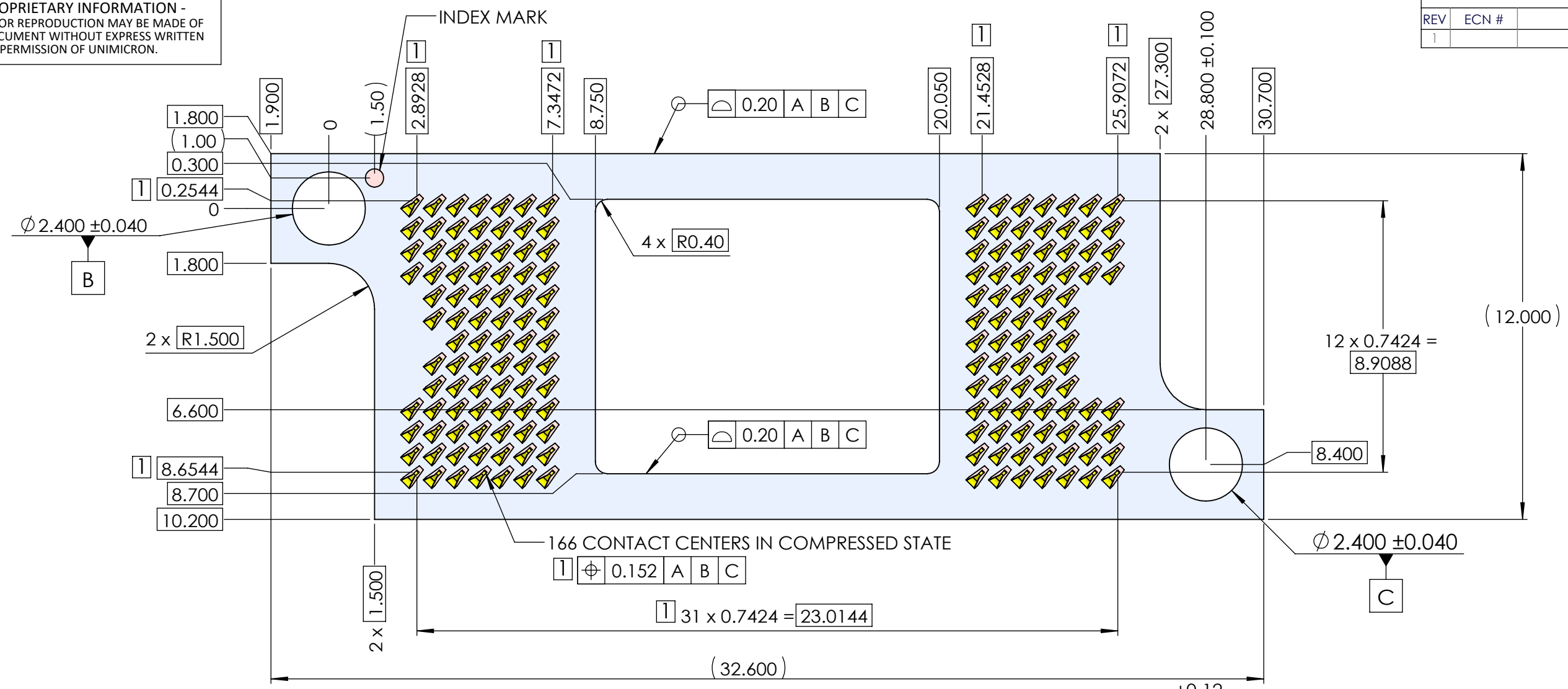


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Revisions			
REV	ECN #	Description	Date
1		Preliminary	2022/12/22



NOTES: UNLESS OTHERWISE SPECIFIED:

- Center Position Of The Contact Area In The Compressed State.
- Height When Contacts Are Fully Compressed Between DMD And PCB.
- Interpret Drawing Per ASME Y14.5-2018.
- Compliant With RoHS Directive 2011/65/EU.



DIMENSIONS ARE IN MM

.X ± 0.15	✓
.XX ± 0.10	
.XXX ± 0.05	
ANGLE: NO DEC ± 1°	
.X ± 0.5°	
.XX ± 0.25°	

THIRD ANGLE

MATERIAL:	
FINISH: --	
DRAWN BY: Winni Cheng	2022/12/22
CHECKED BY: Jason Wu	2022/12/22
ENGR APPR: Gary Hsieh	2022/12/22
MFG APPR:	
QA APPR:	

TITLE:	
166 positions LGA-LGA PCBeam interposer (0.7424 mm pitch) - 1.6mm	
SIZE: B+	DWG NUMBER: BDX0166CMMSXAU00
REV: 1	
SCALE: 6.5:1	SHEET 1 OF 1